

Certificate TW13/11133

The management system of

# Taiwan-Asia Semiconductor Corporation

No. 1, Lixing 5<sup>th</sup> Rd., Hsinchu Science Park, Hsinchu 30078, Taiwan, R.O.C.

has been assessed and certified as meeting the requirements of

## ISO 9001:2015

For the following activities

1. Design and manufacturing of light emitting diode epitaxial wafers, light emitting diode chips, infrared emitting diode chips, photo diode chips, photo transistor chips, zener diode chips, silicon epitaxial wafers, silicon MOSFET chips, schottky diode chips, thermopile detector, optical sensor or receiver IC, LED driver IC, Photo triac, Resistor chips, Light Emitting Diode Package.
2. Assembly, function test and maintenance of wireless & wired communication system application of military.

This certificate is valid from 17 August 2022 until 25 August 2024 and remains valid subject to satisfactory surveillance audits.

Issue 4. Certified since 16 September 2004.

Authorised by  
Jonathan Hall  
Global Head - Certification Services

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Certificate TW13/10530

**SGS**

The management system of

# Taiwan-Asia Semiconductor Corporation

No. 8, Innovation 1<sup>st</sup> Rd., Hsinchu Science Park, Hsinchu 30076, Taiwan, R.O.C.

has been assessed and certified as meeting the requirements of

**ISO 9001:2015**

For the following activities

Design and manufacturing of light emitting diode chips, infrared emitting diode chips, photo diode chips, Vertical-Cavity Surface-Emitting Laser.

This certificate is valid from 17 August 2022 until 25 August 2024 and remains valid subject to satisfactory surveillance audits.

Issue 6. Certified since 16 September 2004.

*Jonathan M. Hall*

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Jonathan Hall  
Global Head - Certification Services

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